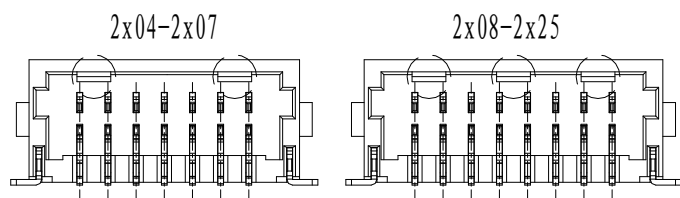
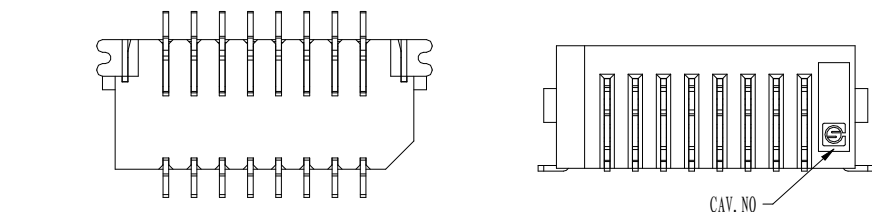


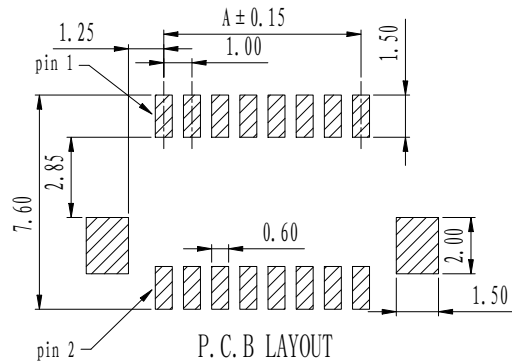
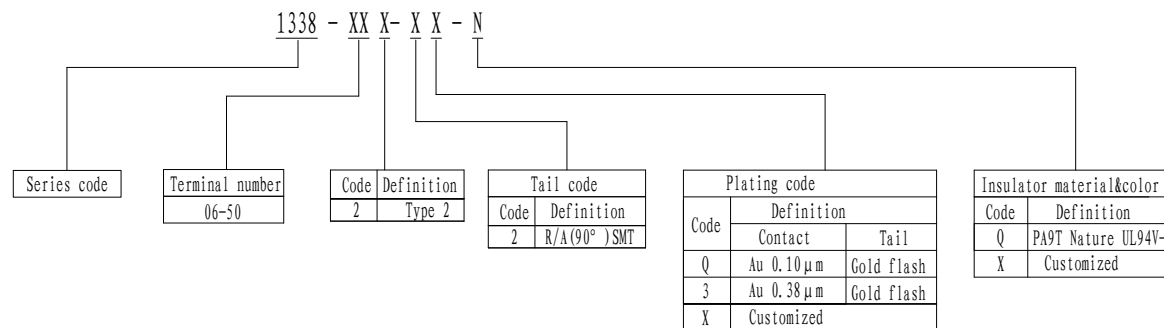
Circuit	A	B
2X03	2.00	5.60
2X04	3.00	6.60
2X05	4.00	7.60
2X06	5.00	8.60
2X07	6.00	9.60
2X08	7.00	10.60
2X09	8.00	11.60
2X10	9.00	12.60
2X11	10.00	13.60
2X15	14.00	17.60
2X20	19.00	22.60
2X25	24.00	27.60

Performance characteristics:

- Main body part material  
Insulator: see part number rule  
Contact terminal: Copper alloy, 1.27μm Ni under plated, outer plating see part number rule  
Solder Nail: Copper alloy, Sn plating solder Area.
- Electrical requirements:  
Current rating: 0.5 A  
Contact resistance: ≤30 mΩ  
Insulation resistance: ≥100 MΩ  
Withstanding voltage: 250 Vr. m.s, 1mA, 60s
- Environment specification  
Working temperature: -40℃ ~ +105℃
- Packing & storing  
Method of packing: Reel, outer box  
Storing condition: Temperature of -10℃ ~ +40℃  
below 80% relative humidity
- Style of installation: SMT
- To prevent the pollution of the environment product info  
RoHS agreement: In line with the European Union RoHS.



CAV. NO



P. C. B LAYOUT  
TOP VIEW

Tolerance: ±0.05

Unless otherwise specified tolerance:

X.	± 0.50	X.°	± 3°
.X	± 0.38	.X°	± 2°
.XX	± 0.25		

Mark	NO.	File NO.	Signature	Date
DRAW			Yong Zhang	2023-10-09
CHK				
MAN				
STD				
APP				

1.00mm Pitch wafer  
STM

1338-XX2-2X-X

SL0.1338.019

Projection	Rev.	Weight	Scale
	A0		

All Dimensions in mm Sheet 1 of 1

SHINNING SHENZHEN SHINNING ELECTRONIC CO.,LTD.